

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6501425

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHENGQUAN HU	01/18/2021
JIANHAN LIU	01/07/2021
THOMAS EDWARD PARE JR.	01/17/2021
RECEIVING PARTY DATA	
Name:	MEDIATEK SINGAPORE PTE. LTD.
Street Address:	NO. 1 FUSIONOPOLIS WALK
Internal Address:	#03-01 SOLARIS
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	138628
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17151621
CORRESPONDENCE DATA	
Fax Number:	(206)792-5742
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	949-383-5384
Email:	pto@haniplaw.com
Correspondent Name:	HAN IP PLLC
Address Line 1:	500 UNION STREET
Address Line 2:	SUITE 800
Address Line 4:	SEATTLE, WASHINGTON 98101
ATTORNEY DOCKET NUMBER:	MDTK.0535US
NAME OF SUBMITTER:	ANDY M. HAN
SIGNATURE:	/Andy M. Han/
DATE SIGNED:	01/18/2021
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	

source=MDTK_0535US_Combined_Declaration_Assignment#page1.tif
source=MDTK_0535US_Combined_Declaration_Assignment#page2.tif
source=MDTK_0535US_Combined_Declaration_Assignment#page3.tif

ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

1. Shengquan Hu
2. Jianhan Liu
3. Thomas Edward Pare, Jr.

Assignee:

MediaTek Singapore Pte. Ltd.
No. 1 Fusionopolis Walk, #03-01 Solaris
Singapore 138628

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of the above-identified invention for which:

provisional application(s) for United States Letters Patent was/were filed on

21 January 2020, 06 February 2020 and 14 February 2020 and was/were given U.S. Serial No(s). **62/963,592, 62/970,778 and 62/976,385, respectively**; and/or

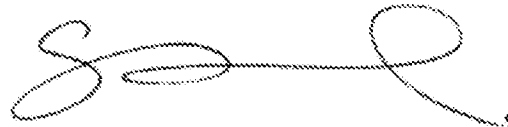
a non-provisional application for United States Letters Patent was/is:


filed on _____ and was given U.S. Serial No. _____; or filed concurrently herewith.


Assignors hereby authorize and request ASSIGNEE's legal representatives, of **Han IP PLLC, 500 Union Street, Suite 800, Seattle, WA 98101**, who are associated with customer number **13859**, to handle all matters related to the above-identified application.

WHEREAS, MediaTek Singapore Pte. Ltd. (hereinafter referred to as ASSIGNEE), a corporation of Singapore having a place of business at No. 1 Fusionopolis Walk, #03-01 Solaris, Singapore 138628, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

Legal Name of First-Named Inventor: Shengquan HU	
Inventor's Signature: 	Date: 1/18/2021
Residence: San Jose, California, U.S.A.	
Citizenship: U.S.A.	
Mailing Address: 2840 Junction Avenue, San Jose, CA 95134, U.S.A.	

Legal Name of Co-Inventor: Jianhan LIU	
Inventor's Signature: 	Date: 01/07/2021
Residence: San Jose, California, U.S.A.	
Citizenship: U.S.A.	
Mailing Address: 2840 Junction Avenue, San Jose, CA 95134, U.S.A.	

Legal Name of Co-Inventor: Thomas Edward PARE, Jr.	
Inventor's Signature: 	Date: 1/17/2021
Residence: San Jose, California, U.S.A.	
Citizenship: U.S.A.	
Mailing Address: 2840 Junction Avenue, San Jose, CA 95134, U.S.A.	